

# HAT2202C

Silicon N Channel MOS FET Power Switching

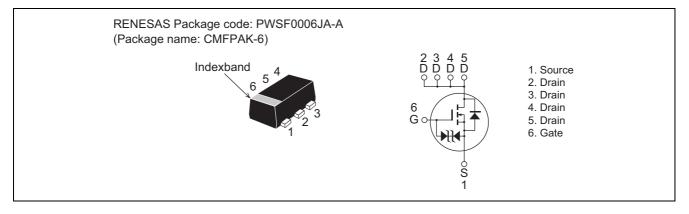
> REJ03G1236-0500 Rev.5.00 Jan 26, 2006

> > $(T_{0} - 25^{\circ}C)$

### Features

- Low on-resistance  $R_{DS(on)} = 31 \text{ m}\Omega \text{ typ.} (at V_{GS} = 4.5 \text{ V})$
- Low drive current.
- High density mounting
- 2.5 V gate drive devices.

### Outline



# **Absolute Maximum Ratings**

		$(1a = 25^{\circ}C)$
Symbol	Ratings	Unit
V <sub>DSS</sub>	20	V
V <sub>GSS</sub>	±12	V
I <sub>D</sub>	3	A
I <sub>D</sub> (pulse) <sup>Note1</sup>	12	A
I <sub>DR</sub>	3	A
Pch <sup>Note 2</sup>	900	mW
Tch	150	°C
Tstg	-55 to +150	٥C
	V <sub>DSS</sub> V <sub>GSS</sub> I <sub>D</sub> I <sub>D</sub> (pulse) <sup>Note1</sup> I <sub>DR</sub> Pch <sup>Note 2</sup> Tch	V <sub>DSS</sub> 20           V <sub>GSS</sub> ±12           I <sub>D</sub> 3           I <sub>D</sub> (pulse) <sup>Note1</sup> 12           I <sub>DR</sub> 3           Pch <sup>Note 2</sup> 900           Tch         150

Notes: 1. PW  $\leq$  10  $\mu s,$  duty cycle  $\leq$  1%

2. When using the glass epoxy board. (FR4  $40 \times 40 \times 1.6$  mm)



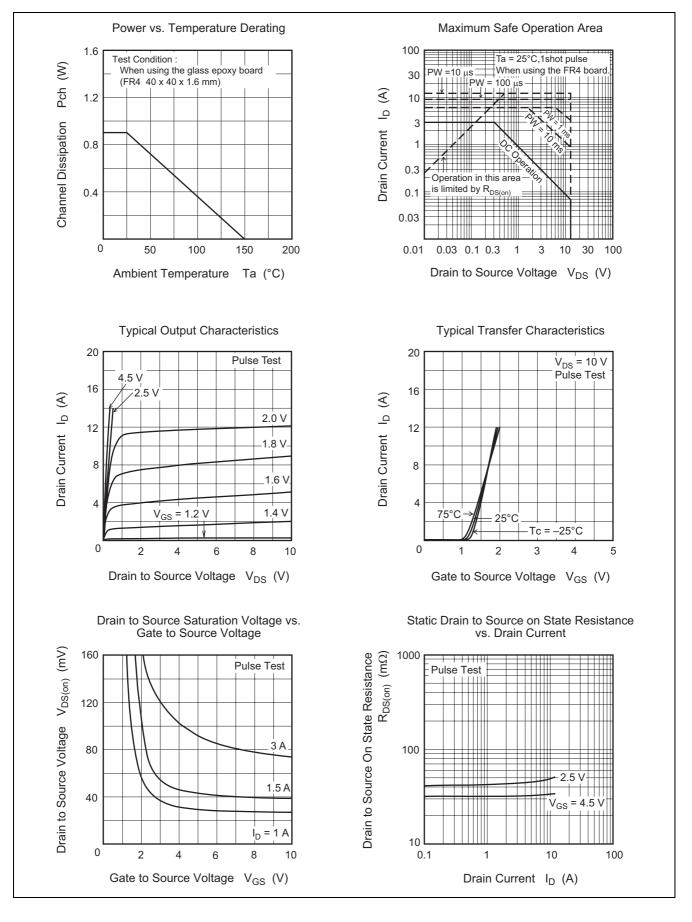
# **Electrical Characteristics**

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to Source breakdown voltage	V <sub>(BR)DSS</sub>	20	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to Source breakdown voltage	V <sub>(BR)GSS</sub>	±12	—	—	V	$I_G = \pm 10 \ \mu A$ , $V_{DS} = 0$
Gate to Source leakage current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS}=\pm~10V,~V_{DS}=0$
Drain to Source leakage current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 20 V, V_{GS} = 0$
Gate to Source cutoff voltage	V <sub>GS(th)</sub>	0.4	_	1.4	V	$I_D = 10 \text{ V}, I_D = 1 \text{ mA}$
Drain to Source on state resistance	R <sub>DS(on)</sub>	_	31	40	mΩ	$I_D = 1.5 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note3}}$
		_	43	55	mΩ	$I_D = 1.5 \text{ A}, V_{GS} = 2.5 \text{ V}^{\text{Note3}}$
Forward transfer admittance	y <sub>fs</sub>	6.5	9.5	_	S	$I_D = 1.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note3}}$
Input capacitance	Ciss	_	520	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss	_	115	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	60	—	pF	
Total gate charge	Qg	_	6	—	nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V},$
Gate to Source charge	Qgs	_	1	—	nC	I <sub>D</sub> = 3 A
Gate to Drain charge	Qgd	_	1.4	—	nC	
Turn - on delay time	t <sub>d(on)</sub>	_	9	—	ns	I <sub>D</sub> = 1.5 A,
Rise time	tr	_	8	—	ns	
Turn - off delay time	t <sub>d(off)</sub>	_	28	_	ns	
Fall time	t <sub>f</sub>	_	6	_	ns	
Body - Drain diode forward voltage	V <sub>DF</sub>	_	0.8	1.1	V	$I_F = 3 \text{ A}, V_{GS} = 0^{Note3}$

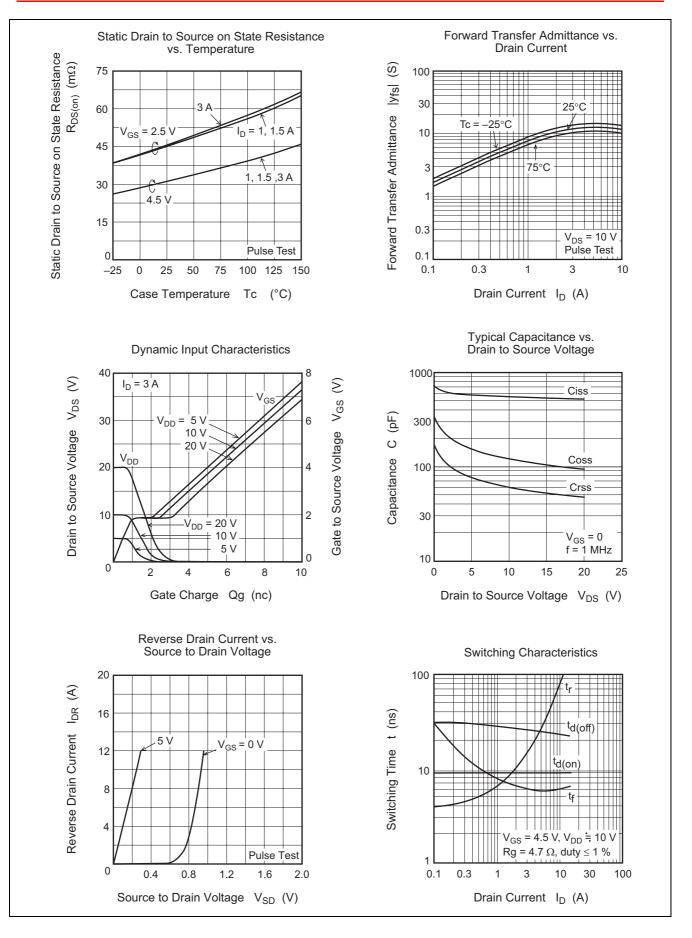
Notes: 3. Pulse test



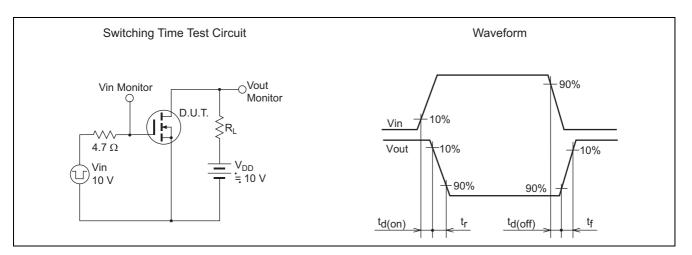
### **Main Characteristics**





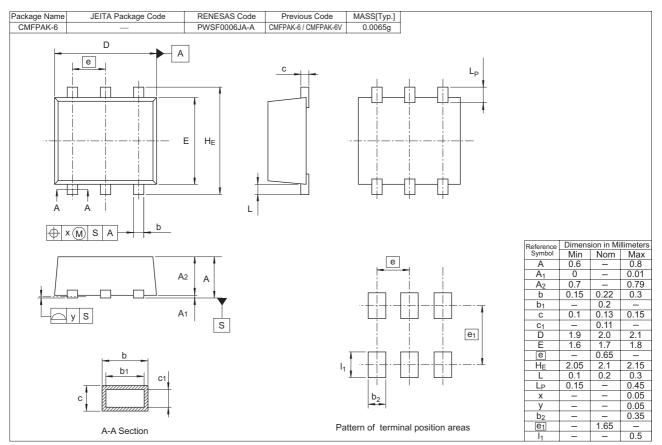








## **Package Dimensions**



# **Ordering Information**

Part Name	Quantity	Shipping Container
HAT2202C-EL-E	3000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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